





FZT1051A

40V NPN MEDIUM POWER HIGH GAIN TRANSISTOR IN SOT223

Features

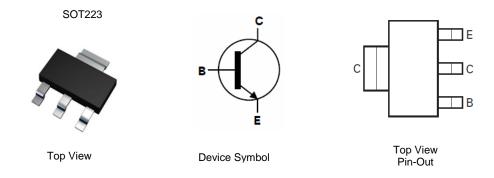
- BV_{CEO} > 40V
- I_C = 5A High Continuous Collector Current
- I_{CM} = 20A Peak Pulse Current
- Low Saturation Voltage V_{CE(sat)} < 120mV @ 1A
- $R_{SAT} = 50 m\Omega$ @ 5A for a Low Equivalent On-Resistance
- h_{FE} Specified up to 10A for a High Gain Hold-Up
- Complementary PNP Type: FZT1151A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound;
 UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ³
- Weight: 0.112 grams (Approximate)

Applications

- Solenoid, Relay and Actuator Drivers
- DC Modules
- Motor Control



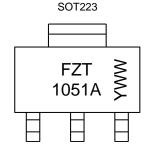
Ordering Information (Note 4)

| Product | Compliance | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|------------|------------|----------|--------------------|-----------------|-------------------|
| FZT1051ATA | AEC-Q101 | FZT1051A | 7 | 12 | 1,000 |
| FZT1051ATC | AEC-Q101 | FZT1051A | 13 | 12 | 4,000 |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



FZT 1051A = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V_{CBO} | 150 | V |
| Collector-Emitter Voltage | V _{CEO} | 40 | V |
| Emitter-Base Voltage | V_{EBO} | 7 | V |
| Continuous Collector Current | Ic | 5 | Α |
| Peak Pulse Current | Ісм | 10 | Α |
| Base Current | Ι _Β | 1 | А |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|---------------------|----------------|----------------------|----|
| | (Note 5) | | 3.0 | |
| Power Dissipation | (Note 6) | ь | 2.0 | W |
| Power Dissipation | (Note 7) | P _D | 1.6 | VV |
| | (Note 8) | | 1.2 | |
| | (Note 5) | | 41.7 | |
| Thermal Resistance, Junction to Ambient | (Note 6) | D | 62.5 | |
| Thermal Resistance, Junction to Ambient | (Note 7) | $R_{	heta JA}$ | R_{θ} JA 78.1 | |
| | (Note 8) | | 104 | |
| Thermal Resistance Junction to Lead (Note 9) | | $R_{	heta JL}$ | 10.9 | |
| Operating and Storage Temperature Range | T_{J} , T_{STG} | -55 to +150 | °C | |

ESD Ratings (Note 10)

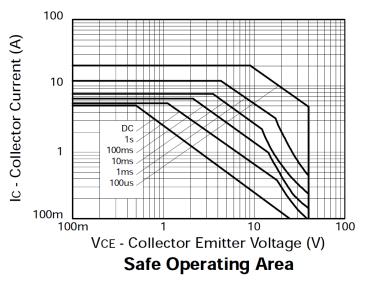
| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 8,000 | V | 3B |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

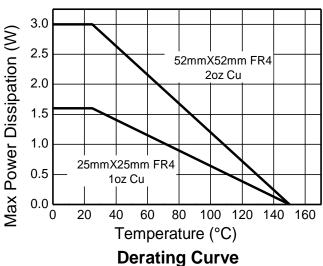
Notes:

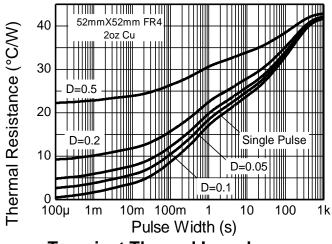
- 5. For a device mounted with the collector lead on 52mm x 52mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
- Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
 Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
 Same as Note 5, except the device is mounted on minimum recommended pad layout.
 Thermal resistance from junction to solder-point (at the end of the collector lead).
- 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

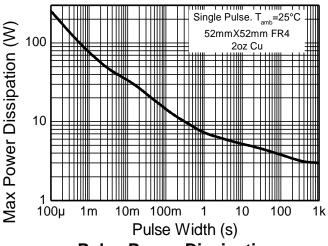


Thermal Characteristics and Derating Information









Transient Thermal Impedance

Pulse Power Dissipation





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Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|---|----------------------|--------|---------|-----------|----------|---|
| Collector-Base Breakdown Voltage | BV _{CBO} | 150 | 190 | _ | V | $I_{C} = 100 \mu A$ |
| Collector-Emitter Breakdown Voltage | BV _{CES} | 150 | 190 | _ | V | $I_{C} = 100 \mu A$ |
| Collector-Emitter Breakdown Voltage | BV _{CEV} | 150 | 190 | _ | V | $I_C = 100\mu A, V_{EB} = 1V$ |
| Collector-Emitter Breakdown Voltage (Note 11) | BV _{CEO} | 40 | 60 | _ | V | $I_C = 10mA$ |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 7 | 8.1 | _ | V | $I_E = 100\mu A$ |
| Collector Cut-Off Current | I _{CBO} | - - | <1 - | 10 0.5 | nΑ μΑ | V _{CB} = 120V V _{CB} = 120V, T _A = +100°C |
| Collector Cut-Off Current | I _{CES} | - | <1 | 10 | nA | V _{CB} = 120V |
| Emitter Cut-Off Current | I _{EBO} | _ | <1 | 10 | nA | V _{EB} = 6V |
| | VCE(sat) | - | 17 | 25 | mV | $I_C = 200 \text{mA}, I_B = 10 \text{mA}$ |
| Collector-Emitter Saturation Voltage (Note 11) | | - | 85 | 120 | | $I_C = 1A$, $I_B = 10mA$ |
| Collector-Entitler Saturation voltage (Note 11) | | - | 140 | 180 | | $I_C = 2A$, $I_B = 20mA$ |
| | | _ | 250 | 340 | | $I_C = 5A$, $I_B = 100mA$ |
| Base-Emitter Saturation Voltage (Note 11) | V _{BE(sat)} | _ | 980 | 1100 | mV | $I_C = 5A$, $I_B = 100mA$ |
| Base-Emitter Turn-On Voltage (Note 11) | V _{BE(on)} | _ | 915 | 1000 | mV | $I_C = 5A$, $V_{CE} = 2V$ |
| | | 290 | 440 | _ | | $I_C = 10$ mA, $V_{CE} = 2$ V |
| DC Current Gain (Note 11) | h _{FE} | 270 | 450 | 1200 | | $I_C = 1A$, $V_{CE} = 2V$ |
| DC Current Gain (Note 11) | | 130 | 220 | _ | _ | $I_C = 5A$, $V_{CE} = 2V$ |
| | | 40 | 55 | _ | | $I_C = 10A, V_{CE} = 2V$ |
| Output Capacitance | C_{obo} | _ | 27 | 40 | pF | V _{CB} = 10V, f = 1MHz |
| Current Gain-Bandwidth Product | f _T | - | 155 | - | MHz | $V_{CE} = 10V, I_{C} = 50mA,$ f = 100MHz |
| Switching Times | t _{on} | = | 220 | - | ns | $I_C = 3A$, $V_{CC} = 10V$, |
| Switching Times | t _{off} | - | 540 | _ | 115 | $I_{B1} = -I_{B2} = 30\text{mA}$ |

Note: 11. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%

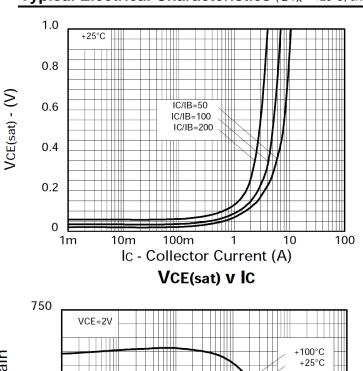


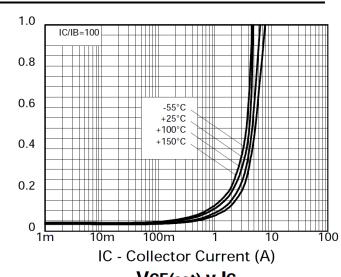
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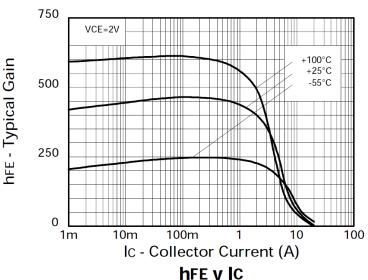
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

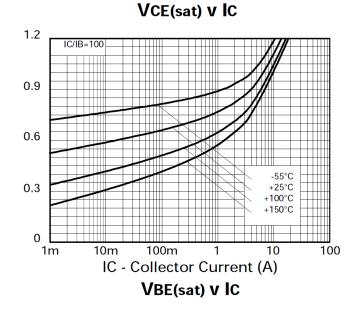
VCE(sat) - (V)

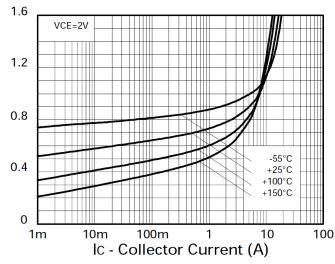
VBE(sat) - (V)









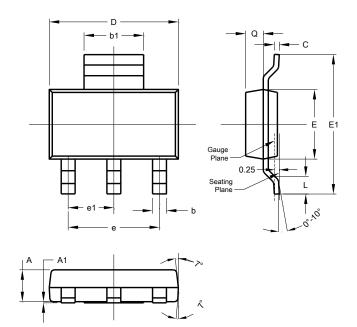






Package Outline Dimensions

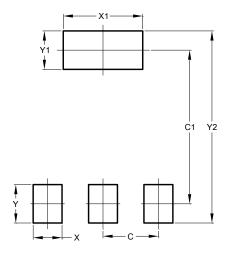
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| SOT223 | | | | | |
|----------------------|-------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.55 | 1.65 | 1.60 | | |
| A1 | 0.010 | 0.15 | 0.05 | | |
| b | 0.60 | 0.80 | 0.70 | | |
| b1 | 2.90 | 3.10 | 3.00 | | |
| С | 0.20 | 0.30 | 0.25 | | |
| D | 6.45 | 6.55 | 6.50 | | |
| Е | 3.45 | 3.55 | 3.50 | | |
| E1 | 6.90 | 7.10 | 7.00 | | |
| е | - | - | 4.60 | | |
| e1 | - | - | 2.30 | | |
| L | 0.85 | 1.05 | 0.95 | | |
| Q | 0.84 | 0.94 | 0.89 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.30 |
| C1 | 6.40 |
| X | 1.20 |
| X1 | 3.30 |
| Y | 1.60 |
| Y1 | 1.60 |
| Y2 | 8.00 |





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